WNSC2D051200



Silicon Carbide Diode

Rev.01 - 21 June 2022

Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO220-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- · Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{i(max)} = 175 °C)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			1200			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 150 °C; Fig. 1; Fig. 2; Fig. 3		5		А	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 5 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; V_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	11	-	nC

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	к_И_А
2	A	anode] ┌─└	K — — — A 001aaa020
mb	mb	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC2D051200	TO220-2L	WNSC2D0512006Q	Tube	50	SOD59A	30-Mar-2015		

7. Marking

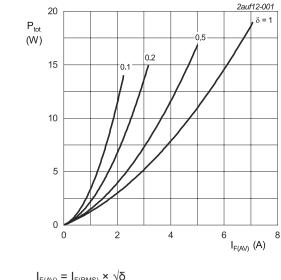
Table 4. Marking codes					
Type number	Marking codes				
WNSC2D051200	WNSC2D 051200				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V _R	reverse voltage	DC		1200	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 150 °C; Fig. 1; Fig. 2; Fig. 3		5	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; T _{mb} ≤ 150 °C; square-wave pulse		10	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		50	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		450	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms		13	A ² s
T _{stg}	storage temperature			-55 to 175	°C
Tj	junction temperature			175	°C



I_{F(AV)} = I_{F(RMS)} × √δ
V_o = 1.027 V; R_s = 0.2336 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

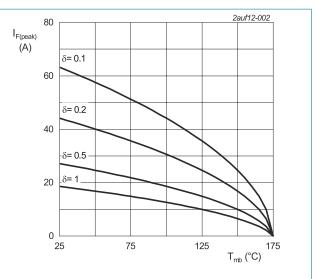
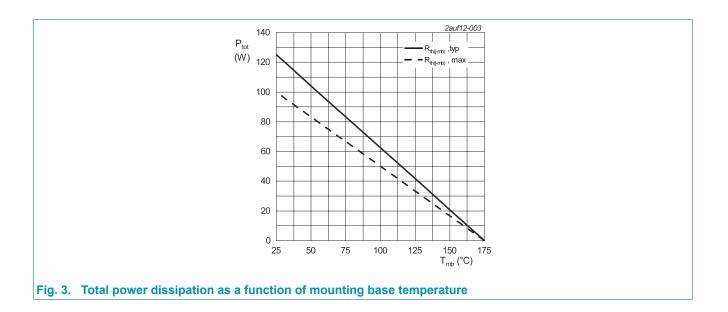


Fig. 2. Current derating as a function of mounting base temperature

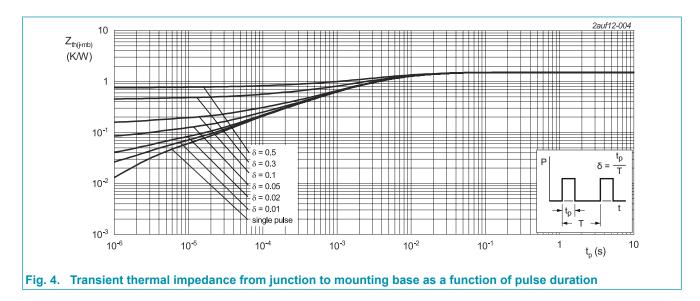
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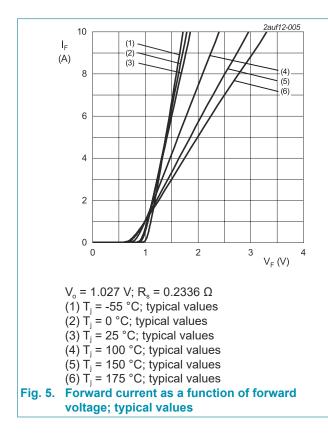
9. Thermal characteristics

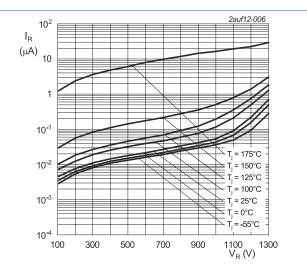
Table 6. Thermal characteristics								
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	1.2	1.5	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W	



10. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
V _F	forward current	I _F = 5 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 5 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	0.5	25	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	25	300	μA
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	11	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	260	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	22	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	16	-	pF
E _{as}	non-repetitive avalanche energy	I_{R} = 2.9 A; L = 10 mH; $T_{j(init)}$ = 25 °C		42	-	-	mJ

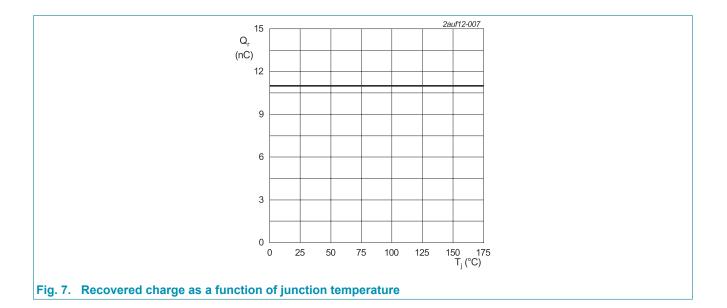






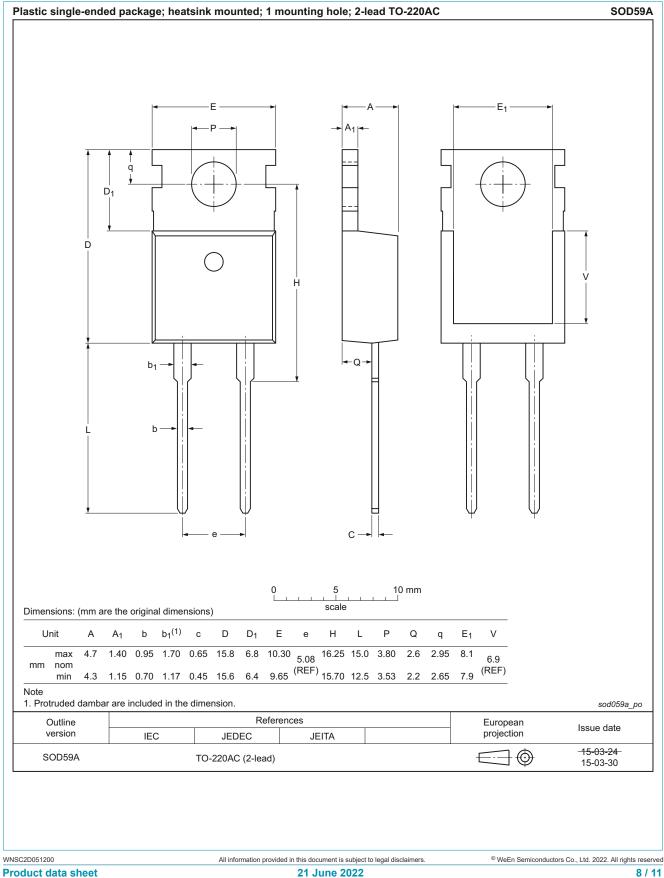
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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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